

Title (en)  
IMPROVED MOBILE ELECTRONIC PARTS

Title (de)  
VERBESSERTE MOBILE ELEKTRONISCHE TEILE

Title (fr)  
PIÈCE ÉLECTRONIQUE MOBILE AMÉLIORÉE

Publication  
**EP 3007896 A1 20160420 (EN)**

Application  
**EP 14728589 A 20140610**

Priority  
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Abstract (en)  
[origin: WO2014198684A1] A mobile electronic part comprising : (i) a shaped metal part, at least part of the surface thereof being coated with at least one polymer layer (L), wherein the metal is selected from a group consisting of magnesium, aluminum and alloys of these metals, and wherein said polymer layer (L) comprises at least one polymer selected from an aromatic polyamide-imide polymer [(PAI) polymer, herein after] or a poly(ethersulfone) polymer [(PESU) polymer herein after], and (ii) a thermoplastic resin composition layer [layer (T), herein after] fixed to the at least one polymer layer (L) of said shaped metal part wherein said composition comprises at least one thermoplastic polymer [polymer (T), herein after].

IPC 8 full level  
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Citation (search report)  
See references of WO 2014198684A1

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